

05N50-SE

Preliminary

Power MOSFET

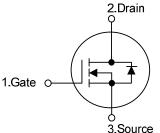
0.5A, 500V N-CHANNEL **POWER MOSFET**

DESCRIPTION

The UTC 05N50-SE is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient AC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)} \le 13 \Omega$ @ V_{GS}=10V, I_D=0.25A
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness
- SYMBOL

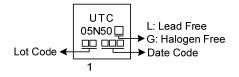


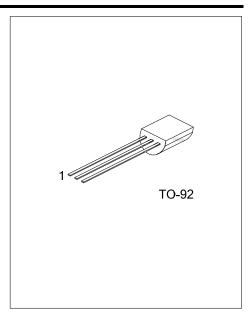
ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Decking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
05N50L-T92-B	05N50G-T92-B	TO-92	G	D	S	Tape Box	
05N50L-T92-K	05N50G-T92-K	TO-92	G	D	S	Bulk	
Note: Pin Assignment: G: Gate D: Drain S: Source							

05N50G-T92-B (1)Packing Type (2)Package Type (3)Green Package	(1) B: Tape Box, K: Bulk (2) T92: TO-92 (3) G: Halogen Free and Lead Free, L: Lead Free
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MARKING





ABSOLUTE MAXIMUM RATINGS (T_c = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	500	V
Gate-Source Voltage		V _{GSS}	±30	V
Drain Current	Continuous	I _D	0.5	А
	Pulsed (Note 2)	I _{DM}	1.0	А
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.27	V/ns
Power Dissipation		PD	0.9	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. $I_{SD} \le 0.5A$, di/dt $\le 200A/\mu s$, $V_R = 200V$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA (NOTE)

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ _{JA}	160	°C/W	
Junction to Case	θ _{JC}	122	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

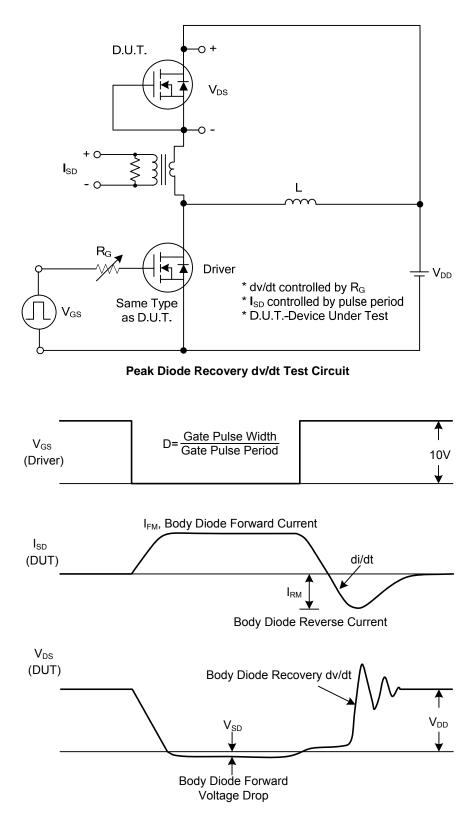
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

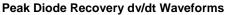
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250µA	500			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =500V, V _{GS} =0V			10	μA
Gate-Source Leakage Current	Forward		V _{GS} =30V, V _{DS} =0V			100	nA
	Reverse	I _{GSS}	V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =0.25A			13	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		CISS			59.6		рF
Output Capacitance		C _{OSS}	V _{DS} =25V, V _{GS} =0V, f=1MHz		11.7		рF
Reverse Transfer Capacitance		C _{RSS}			1.68		рF
SWITCHING CHARACTERISTIC	S					-	
Total Gate Charge (Note 1)		Q_{G}			6.42		nC
Gate to Source Charge		Q_{GS}	V _{DS} =400V, V _{GS} =10V, I _D =0.5A, I _G =1mA (Note 1, 2)		2		nC
Gate to Drain Charge		Q_{GD}			0.3		nC
Turn-ON Delay Time (Note 1)		t _{D (ON)}	-		4		ns
Rise Time		t _R	V _{DD} =100V, V _{GS} =10V, I _D =0.5A,		14		ns
Turn-OFF Delay Time		t _{D (OFF)}	R _G =25Ω (Note 1, 2)		12		ns
all-Time		t _F			39.1		ns
DRAIN-SOURCE DIODE CHARA	ACTERISTICS	AND MAXI	MUM RATINGS				
Maximum Body-Diode Continuous Current		ls	-			0.5	Α
Maximum Body-Diode Pulsed Current (Note 1)		I _{SM}				1.0	Α
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =0.5A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		t _{rr}	I _S =0.5A, V _{GS} =0V		82		ns
Body Diode Reverse Recovery Charge		Qrr	dI _F /dt=100A/µs		0.2		μC

Notes: 1. Pulse Test: Pulse Width≤300µs, Duty Cycle≤2%

2. Essentially independent of operating temperature.

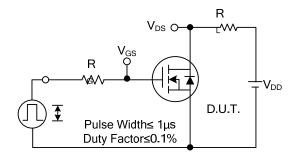
TEST CIRCUITS AND WAVEFORMS



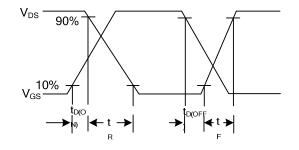


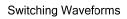


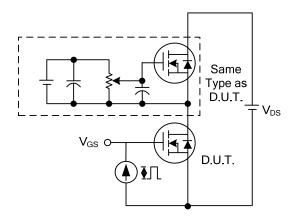
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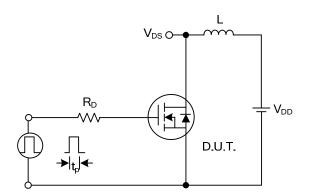
Switching Test Circuit



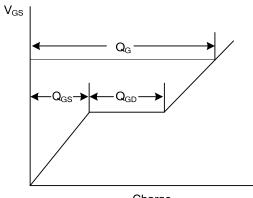






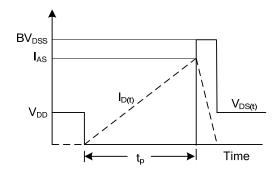


Unclamped Inductive Switching Test Circuit



Charge

Gate Charge Waveform



Unclamped Inductive Switching Waveforms



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